Renesas Electronics America Inc - R5F562T6BDFM#V3 Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	37
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562t6bdfm-v3

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and Table 1.2 lists the functions of products.

Table 1.1 Outline of Specifications (1 / 5)

Classification	Module/Function	Description
CPU	CPU	• Maximum operating frequency: 100MHz • 32-bit RX CPU • Minimum instruction execution time: One instruction per state (cycle of the system clock) • Address space: 4-Gbyte linear • Register set of the CPU • General purpose: Sixteen 32-bit registers • Control: Nine 32-bit registers • Accumulator: One 64-bit register • Basic instructions: 73 • Floating-point instructions: 8 • DSP instructions: 9 • Addressing modes: 10 • Data arrangement • Instructions: Little endian • Data: Selectable as little endian or big endian • On-chip 32-bit multiplier: 32 x 32 → 64 bits • On-chip divider: 32 / 32 → 32 bits • Barrel shifter: 32 bits • Memory-protection unit (MPU)
	FPU	• Single precision (32-bit) floating point • Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	• ROM capacity: 256 Kbytes (max.) • Two on-board programming modes • Boot mode (The user MAT is programmable via the SCI) • User program mode • Off-board programming • A PROM programmer can be used to program the user mat.
	RAM	• RAM capacity: 16 Kbytes (max.)
	Data flash	• Data flash capacity: 32 Kbytes (max.) • Supports background operations (BGO)
MCU operating mode		• Single-chip mode
Clock	Clock generation circuit	• One circuit: Main clock oscillator • Internal oscillator: Low-speed on-chip oscillator dedicated to IWDT • Structure of a PLL frequency synthesizer and frequency divider for selectable operating frequency • Oscillation stoppage detection • Independent frequency-division and multiplication settings for the system clock (ICLK) and peripheral module clock (PCLK) • The CPU and system sections such as other bus masters, MTU3, and GPT run in synchronization with the system clock (ICLK): 8 to 100 MHz. • Peripheral modules run in synchronization with the peripheral module clock (PCLK): 8 to 50 MHz
Reset		Pin reset, power-on reset (automatic power-on reset when the power is turned on), voltage-monitoring reset, watchdog timer reset, independent watchdog timer reset, and deep software standby reset
Voltage detection circuit (LVD)		When the voltage on VCC falls below the voltage detection level (Vdet), an internal reset or internal interrupt is generated.
Low power consumption	Low power consumption facilities	• Module stop function • Four low power consumption modes • Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode

Table 1.1 Outline of Specifications (3 / 5)

Classification	Module/Function	Description
Timers	General PWM timer (GPT/GPTa)	• 16 bits x 4 channels • Counting up or down (saw-wave), counting up and down (triangle-wave) selectable for all channels • Clock sources independently selectable for all channels • 2 input/output pins per channel • 2 output compare/input capture registers per channel • For the 2 output compare/input capture registers of each channel, 4 registers are provided as buffer registers and are capable of operating as comparison registers when buffering is not in use. • In output compare operation, buffer switching can be at peaks or troughs, enabling the generation of laterally asymmetrically PWM waveforms. • Registers for setting up frame intervals on each channel (with capability for generating interrupts on overflow or underflow) • Synchronizable operation of the several counters • Modes of synchronized operation (synchronized, or displaced by desired times for phase shifting) • Generation of dead times in PWM operation • Through combination of three counters, generation of automatic three-phase PWM waveforms incorporating dead times • Starting, clearing, and stopping counters in response to external or internal triggers • Internal trigger sources: output of the internal comparator detection, software, and compare-match • The frequency-divided system clock (ICLK) can be used as a counter clock for measuring timing of the edges of signals produced by frequency-dividing the low-speed on-chip oscillator clock signal dedicated to IWDT (to detect abnormal oscillation). • PWM delay generation can control the timing with which signals on the two PWM output pins for each channel rise and fall with an accuracy of up to 1/32 times the period of the system clock (ICLK) (only for GPTa).
	Compare match timer (CMT)	• (16 bits x 2 channels) x 2 units • Select from among four internal clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Watchdog timer (WDT)	• 8 bits x 1 channel • Select from among eight counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192, PCLK/32768, PCLK/131072) • Switchable between watchdog timer mode and interval timer mode
	Independent watchdog timer (IWDT)	• 14 bits x 1 channel • Counter-input clock: low-speed on-chip oscillator dedicated to IWDT
Communications	Serial communications interface (SCIb)	• 3 channels • Serial communications modes: Asynchronous, clock synchronous, and smart-card interface • Multiprocessor communications • On-chip baud rate generator allows selection of the desired bit rate • Choice of LSB-first or MSB-first transfer • Noise cancellation (only available in asynchronous mode)
	I^2C bus interface (RIIC)	• 1 channel • Communications formats I^2C bus format/SMBus format Master/slave selectable

Table 1.6 List of Pins and Pin Functions (80-Pin LQFP) (1 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debugging
1	EMLE							
2	VSS							
3	MDE							
4	VCL							
5	MD1							
6	MD0							
7		PE4		MTCLKC-C		IRQ1-B	POE10#-B	
8		PE3		MTCLKD-C		IRQ2-A	POE11#	
9	RES#							
10	XTAL							
11	VSS							
12	EXTAL							
13	VCC							
14		PE2				NMI	POE10#-A	
15		PE0			CRX-C			
16		PD7		GTIOC0A-B	CTX-C			TRST#
17		PD6		GTIOC0B-B				TMS
18		PD5		GTIOC1A-B	RXD1			TDI
19		PD4		GTIOC1B-B	SCK1			TCK
20		PD3		GTIOC2A-B	TXD1			TDO
21		PB7			SCK2-A			
22		PB6			CRX-A/ RXD2-A			
23		PB5			CTX-A/ TXD2-A			
24	PLLVCC							
25		PB4		GTETRG		IRQ3	POE8#	
26	PLLVSS							
27		PB3		MTIOC0A-A	SCK0			
28		PB2		MTIOC0B-A	TXD0/SDA			
29		PB1		MTIOC0C	RXD0/SCL			
30		PB0		MTIOC0D	MOSI-B			
31		PA3		MTIOC2A	SSL0-B			
32		PA2		MTIOC2B	SSL1-B			
33	VCC							
34		P96				IRQ4	POE4#	
35	VSS							
36		P95		MTIOC6B				
37		P94		MTIOC7A				
38		P93		MTIOC7B				
39		P92		MTIOC6D				
40		P91		MTIOC7C				
41		P76		MTIOC4D/ GTIOC2B-A				

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

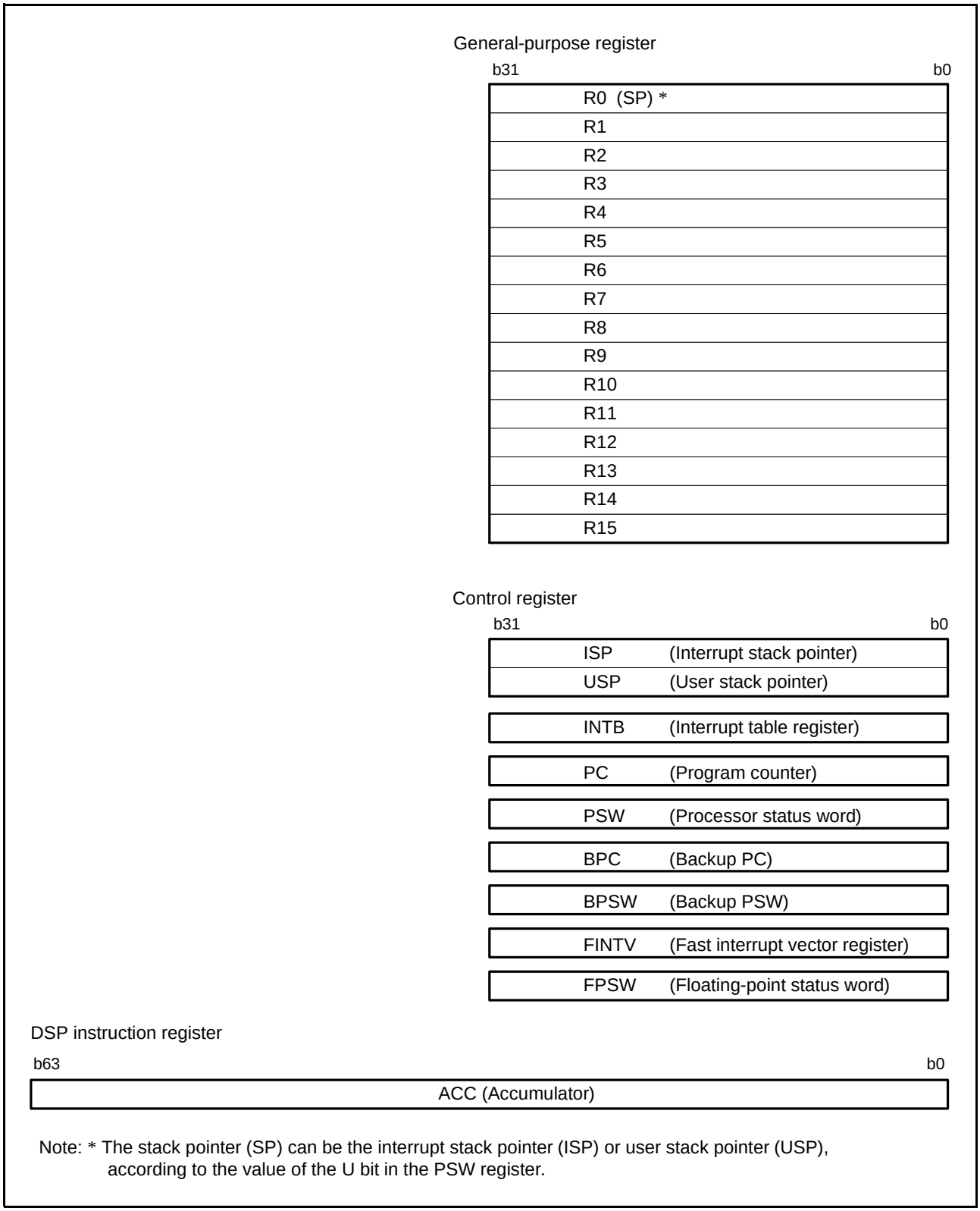


Figure 2.1 Register Set of the CPU

Table 4.1 List of I/O Registers (Address Order) (17 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
000C 123Ah	MTU	Timer interrupt skipping mode register A	TITMRA	8	8	5 ICLK
000C 123Bh	MTU	Timer interrupt skipping set register 2A	TITCR2A	8	8	5 ICLK
000C 123Ch	MTU	Timer interrupt skipping counter 2A	TITCNT2A	8	8	5 ICLK
000C 1240h	MTU4	Timer A/D converter start request control register	TADCR	16	16	5 ICLK
000C 1244h	MTU4	Timer A/D converter start request cycle set register A	TADCORA	16	16, 32	5 ICLK
000C 1246h	MTU4	Timer A/D converter start request cycle set register B	TADCORB	16	16	5 ICLK
000C 1248h	MTU4	Timer A/D converter start request cycle set buffer register A	TADCOBRA	16	16, 32	5 ICLK
000C 124Ah	MTU4	Timer A/D converter start request cycle set buffer register B	TADCOBRB	16	16	5 ICLK
000C 1260h	MTU	Timer waveform control register A	TWCRA	8	8	5 ICLK
000C 1270h	MTU3	Timer mode register 2A	TMDR2A	8	8	5 ICLK
000C 1272h	MTU3	Timer general register E	TGRE	16	16	5 ICLK
000C 1274h	MTU4	Timer general register E	TGRE	16	16	5 ICLK
000C 1276h	MTU4	Timer general register F	TGRF	16	16	5 ICLK
000C 1280h	MTU	Timer start register A	TSTRA	8	8, 16	5 ICLK
000C 1281h	MTU	Timer synchronous register A	TSYRA	8	8	5 ICLK
000C 1282h	MTU	Timer counter synchronous start register	TCSYSTR	8	8	5 ICLK
000C 1284h	MTU	Timer read/write enable register A	TRWERA	8	8	5 ICLK
000C 1300h	MTU0	Timer control register	TCR	8	8, 16, 32	5 ICLK
000C 1301h	MTU0	Timer mode register 1	TMDR1	8	8	5 ICLK
000C 1302h	MTU0	Timer I/O control register H	TIORH	8	8, 16	5 ICLK
000C 1303h	MTU0	Timer I/O control register L	TIORL	8	8	5 ICLK
000C 1304h	MTU0	Timer interrupt enable register	TIER	8	8, 16, 32	5 ICLK
000C 1305h	MTU0	Timer status register	TSR	8	8	5 ICLK
000C 1306h	MTU0	Timer counter	TCNT	16	16	5 ICLK
000C 1308h	MTU0	Timer general register A	TGRA	16	16, 32	5 ICLK
000C 130Ah	MTU0	Timer general register B	TGRB	16	16	5 ICLK
000C 130Ch	MTU0	Timer general register C	TGRC	16	16, 32	5 ICLK
000C 130Eh	MTU0	Timer general register D	TGRD	16	16	5 ICLK
000C 1320h	MTU0	Timer general register E	TGRE	16	16, 32	5 ICLK
000C 1322h	MTU0	Timer general register F	TGRF	16	16	5 ICLK
000C 1324h	MTU0	Timer interrupt enable register 2	TIER2	8	8, 16	5 ICLK
000C 1325h	MTU0	Timer status register 2	TSR2	8	8	5 ICLK
000C 1326h	MTU0	Timer buffer operation transfer mode register	TBTM	8	8	5 ICLK
000C 1380h	MTU1	Timer control register	TCR	8	8, 16	5 ICLK
000C 1381h	MTU1	Timer mode register 1	TMDR1	8	8	5 ICLK
000C 1382h	MTU1	Timer I/O control register	TIOR	8	8	5 ICLK
000C 1384h	MTU1	Timer interrupt enable register	TIER	8	8, 16, 32	5 ICLK
000C 1385h	MTU1	Timer status register	TSR	8	8	5 ICLK
000C 1386h	MTU1	Timer counter	TCNT	16	16	5 ICLK
000C 1388h	MTU1	Timer general register A	TGRA	16	16, 32	5 ICLK
000C 138Ah	MTU1	Timer general register B	TGRB	16	16	5 ICLK

Table 4.1 List of I/O Registers (Address Order) (19 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
000C 1A39h	MTU7	Timer buffer operation transfer mode register	TBTM	8	8	5 ICLK
000C 1A3Ah	MTU	Timer interrupt skipping mode register B	TITMRB	8	8	5 ICLK
000C 1A3Bh	MTU	Timer interrupt skipping set register 2B	TITCR2B	8	8	5 ICLK
000C 1A3Ch	MTU	Timer interrupt skipping counter 2B	TITCNT2B	8	8	5 ICLK
000C 1A40h	MTU7	Timer A/D converter start request control register	TADCR	16	16	5 ICLK
000C 1A44h	MTU7	Timer A/D converter start request cycle set register A	TADCORA	16	16, 32	5 ICLK
000C 1A46h	MTU7	Timer A/D converter start request cycle set register B	TADCORB	16	16	5 ICLK
000C 1A48h	MTU7	Timer A/D converter start request cycle set buffer register A	TADCOBRA	16	16, 32	5 ICLK
000C 1A4Ah	MTU7	Timer A/D converter start request cycle set buffer register B	TADCOBRB	16	16	5 ICLK
000C 1A50h	MTU6	Timer synchronous clear register	TSYCR	8	8	5 ICLK
000C 1A60h	MTU	Timer waveform control register B	TWCRB	8	8	5 ICLK
000C 1A70h	MTU	Timer mode register 2B	TMDR2B	8	8	5 ICLK
000C 1A72h	MTU6	Timer general register E	TGRE	16	16	5 ICLK
000C 1A74h	MTU7	Timer general register E	TGRE	16	16	5 ICLK
000C 1A76h	MTU7	Timer general register F	TGRF	16	16	5 ICLK
000C 1A80h	MTU	Timer start register B	TSTRB	8	8, 16	5 ICLK
000C 1A81h	MTU	Timer synchronous register B	TSYRB	8	8	5 ICLK
000C 1A84h	MTU	Timer read/write enable register B	TRWERB	8	8	5 ICLK
000C 1C80h	MTU5	Timer counter U	TCNTU	16	16, 32	5 ICLK
000C 1C82h	MTU5	Timer general register U	TGRU	16	16	5 ICLK
000C 1C84h	MTU5	Timer control register U	TCRU	8	8	5 ICLK
000C 1C86h	MTU5	Timer I/O control register U	TIORU	8	8	5 ICLK
000C 1C90h	MTU5	Timer counter V	TCNTV	16	16, 32	5 ICLK
000C 1C92h	MTU5	Timer general register V	TGRV	16	16	5 ICLK
000C 1C94h	MTU5	Timer control register V	TCRV	8	8	5 ICLK
000C 1C96h	MTU5	Timer I/O control register V	TIORV	8	8	5 ICLK
000C 1CA0h	MTU5	Timer counter W	TCNTW	16	16, 32	5 ICLK
000C 1CA2h	MTU5	Timer general register W	TGRW	16	16	5 ICLK
000C 1CA4h	MTU5	Timer control register W	TCRW	8	8	5 ICLK
000C 1CA6h	MTU5	Timer I/O control register W	TIORW	8	8	5 ICLK
000C 1CB0h	MTU5	Timer status register	TSR	8	8	5 ICLK
000C 1CB2h	MTU5	Timer interrupt enable register	TIER	8	8	5 ICLK
000C 1CB4h	MTU5	Timer start register	TSTR	8	8	5 ICLK
000C 1CB6h	MTU5	Timer compare match clear register	TCNTCMPCLR	8	8	5 ICLK
000C 2000h	GPT	General PWM timer software start register	GTSTR	16	8, 16, 32	3 to 5 ICLK*4
000C 2004h	GPT	General PWM timer hardware source start control register	GTHSCR	16	8, 16, 32	3 to 5 ICLK*4
000C 2006h	GPT	General PWM timer hardware source clear control register	GTHCCR	16	8, 16, 32	3 to 5 ICLK*4
000C 2008h	GPT	General PWM timer hardware start source select register	GTHSSR	16	8, 16, 32	3 to 5 ICLK*4

Table 4.2 List of I/O Registers (Bit Order) (14 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
PORT8	DR	—	—	—	—	—	B2	B1	B0
PORT9	DR	—	B6	B5	B4	B3	B2	B1	B0
PORTA	DR	—	—	B5	B4	B3	B2	B1	B0
PORTB	DR	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	DR	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	DR	—	—	B5	B4	B3	—	B1	B0
PORTG	DR	—	—	B5	B4	B3	B2	B1	B0
PORT1	PORT	—	—	—	—	—	—	B1	B0
PORT2	PORT	—	—	—	B4	B3	B2	B1	B0
PORT3	PORT	—	—	—	—	B3	B2	B1	B0
PORT4	PORT	B7	B6	B5	B4	B3	B2	B1	B0
PORT5	PORT	—	—	B5	B4	B3	B2	B1	B0
PORT6	PORT	—	—	B5	B4	B3	B2	B1	B0
PORT7	PORT	—	B6	B5	B4	B3	B2	B1	B0
PORT8	PORT	—	—	—	—	—	B2	B1	B0
PORT9	PORT	—	B6	B5	B4	B3	B2	B1	B0
PORTA	PORT	—	—	B5	B4	B3	B2	B1	B0
PORTB	PORT	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	PORT	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	PORT	—	—	B5	B4	B3	B2	B1	B0
PORTG	PORT	—	—	B5	B4	B3	B2	B1	B0
PORT1	ICR	—	—	—	—	—	—	B1	B0
PORT2	ICR	—	—	—	B4	B3	B2	B1	B0
PORT3	ICR	—	—	—	—	B3	B2	B1	B0
PORT4	ICR	B7	B6	B5	B4	B3	B2	B1	B0
PORT5	ICR	—	—	B5	B4	B3	B2	B1	B0
PORT6	ICR	—	—	B5	B4	B3	B2	B1	B0
PORT7	ICR	—	B6	B5	B4	B3	B2	B1	B0
PORT8	ICR	—	—	—	—	—	B2	B1	B0
PORT9	ICR	—	B6	B5	B4	B3	B2	B1	B0
PORTA	ICR	—	—	B5	B4	B3	B2	B1	B0
PORTB	ICR	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	ICR	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	ICR	—	—	B5	B4	B3	—	B1	B0
PORTG	ICR	—	—	B5	B4	B3	B2	B1	B0
IOPORT	PF8IRQ	—	—	—	—	ITS1[1:0]		ITS0[1:0]	
IOPORT	PF9IRQ	—	—	—	—	—	ITS2	—	—
IOPORT	PFAADC	—	—	—	—	—	—	ADTRG1S	ADTRG0S
IOPORT	PFCMTU	TCLKS[1:0]		—	—	—	—	MTUS1	MTUS0
IOPORT	PFDGPT	—	—	—	—	—	—	—	GPTS
IOPORT	PFFSCI	—	—	—	—	—	SCI2S	—	—
IOPORT	PFGSPI	SSL3E	SSL2E	SSL1E	SSL0E	MISOE	MOSIE	RSPCKE	—
IOPORT	PFHSPI	—	—	—	—	—	—	RSPIS[1:0]	
IOPORT	PFJCAN	CANS[1:0]		—	—	—	—	—	CANE
IOPORT	PFKLIN	—	—	—	—	—	—	—	LINE
IOPORT	PFMPOE	—	—	—	POE11E	POE10E	POE8E	POE4E	POE0E
IOPORT	PFNPOE	POE10S	—	—	—	—	—	—	—
SYSTEM	DPSBYCR	DPSBY	IOKEEP	—	—	—	—	—	—
SYSTEM	DPSWCR	—	—	WTSTS[5:0]					
SYSTEM	DPSIER	DNMIE	—	—	DLVDE	—	—	DIRQ1E	DIRQ0E

Table 4.2 List of I/O Registers (Bit Order) (22 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
MTU7	TADCOBRB								
MTU	TSYCR	CE0A	CE0D	CE0C	CE0D	CE1A	CE1B	CE2A	CE2B
MTU	TWCRB	CCE	—	—	—	—	—	SCC	WRE
MTU	TMDR2B	—	—	—	—	—	—	—	DRS
MTU6	TGRE								
MTU7	TGRE								
MTU7	TGRF								
MTU	TSTRB	CST7	CST6	—	—	—	—	—	—
MTU	TSYRB	SYNC7	SYNC6	—	—	—	—	—	—
MTU	TRWERB	—	—	—	—	—	—	—	RWE
MTU5	TCNTU								
MTU5	TGRU								
MTU5	TCRU	—	—	—	—	—	—	TPSC[1:0]	
MTU5	TIORU	—	—	—			IOC[4:0]		
MTU5	TCNTV								
MTU5	TGRV								
MTU5	TCRV	—	—	—	—	—	—	TPSC[1:0]	
MTU5	TIORV	—	—	—			IOC[4:0]		
MTU5	TCNTW								
MTU5	TGRW								
MTU5	TCRW	—	—	—	—	—	—	TPSC[1:0]	
MTU5	TIORW	—	—	—			IOC[4:0]		
MTU5	TSR	—	—	—	—	—	CMFU5	CMFV5	CMFW5
MTU5	TIER	—	—	—	—	—	TGIE5U	TGIE5V	TGIE5W
MTU5	TSTR	—	—	—	—	—	CSTU5	CSTV5	CSTW5
MTU5	TCNTCMPCLR	—	—	—	—	—	CMPCLR5U	CMPCLR5V	CMPCLR5W
GPT	GTSTR	—	—	—	—	—	—	—	—
		—	—	—	—	CST3	CST2	CST1	CST0
GPT	GTHSCR	CPHW3[1:0]		CPHW2[1:0]		CPHW1[1:0]		CPHW0[1:0]	
		CSHW3[1:0]		CSHW2[1:0]		CSHW1[1:0]		CSHW0[1:0]	
GPT	GTHCCR	—	—	—	—	CCSW3	CCSW2	CCSW1	CCSW0
		CCHW3[1:0]		CCHW2[1:0]		CCHW1[1:0]		CCHW0[1:0]	
GPT	GTHSSR	CSHSL3[3:0]					CSHSL2[3:0]		
		CSHSL1[3:0]					CSHSL0[3:0]		
GPT	GTHPSR	CSHPL3[3:0]					CSHPL2[3:0]		
		CSHPL1[3:0]					CSHPL0[3:0]		
GPT	GTWP	—	—	—	—	—	—	—	—
		—	—	—	—	WP3	WP2	WP1	WP0
GPT	GTSYNC	—	—	SYNC3[1:0]		—	—	SYNC2[1:0]	
		—	—	SYNC1[1:0]		—	—	SYNC0[1:0]	
GPT	GTETINT	—	—	—	—	—	—	ETINF	ETIPF
		—	—	—	—	—	—	ETINEN	ETIPEN

Table 4.2 List of I/O Registers (Bit Order) (24 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
GPT0	GTCR	—	—	CCLR[1:0]		—	—	TPCS[1:0]	
		—	—	—	—	—		MD[2:0]	
GPT0	GTBER	—	ADTDB	ADTTB[1:0]		—	ADTDA	ADTTA[1:0]	
		—	CCRSWT	PR[1:0]		CCRB[1:0]		CCRA[1:0]	
GPT0	GTUDC	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	UDF	UD
GPT0	GTITC	—	ADTBL	—	ADTAL	—	IVTT[2:0]		
		IVTC[1:0]		ITLF	ITLE	ITLD	ITLC	ITLB	ITLA
GPT0	GTST	TUCF	—	—	—	DTEF		ITCNT[2:0]	
		TCFPU	TCFPO	TCFF	TCFE	TCFD	TCFC	TCFB	TCFA
GPT0	GTCNT								
GPT0	GTCCRA								
GPT0	GTCCRB								
GPT0	GTCCRC								
GPT0	GTCCRD								
GPT0	GTCCRE								
GPT0	GTCCRF								
GPT0	GTPR								
GPT0	GTPBR								
GPT0	GTPDBR								
GPT0	GTADTRA								
GPT0	GTADTBRA								
GPT0	GTADTDBRA								
GPT0	GTADTRB								
GPT0	GTADTBRB								
GPT0	GTADTDBRB								
GPT0	GTONCR	OBE	OAE	—	SWN	—	—	—	NFV
			NFS[3:0]			NVB	NVA	NEB	NEA
GPT0	GTDTCR	—	—	—	—	—	—	—	TDFER
		—	—	TDBDE	TDBUE	—	—	—	TDE
GPT0	GTDVU								
GPT0	GTDVD								

5.2 DC Characteristics

Table 5.2 DC Characteristics (1) (1 / 3)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	CAN input pin IRQ input pin MTU3 input pin POE3 input pin SCI input pin A/D trigger input pin NMI input pin GPT input pin LIN input pin RES#	V_{IH}	VCC×0.8	-	VCC+0.3	V	
		V_{IL}	-0.3	-	VCC×0.2		
		ΔV_T	VCC ×0.06	-	-		
	RIIC input pin (IICBus)	V_{IH}	VCC×0.7	-	VCC+0.3		
		V_{IL}	-0.3	-	VCC×0.3		
		ΔV_T	VCC ×0.05	-	-		
	Port 4*1 (also usable as an analog port)	V_{IH}	AVCC0 ×0.8	-	AVCC0 +0.3		
		V_{IL}	- 0.3	-	AVCC0 ×0.2		
		ΔV_T	AVCC0 ×0.06	-	-		
	Ports 5 and 6*1 (also usable as analog ports)	V_{IH}	AVCC ×0.8	-	AVCC +0.3		
		V_{IL}	-0.3	-	AVCC ×0.2		
		ΔV_T	AVCC ×0.06	-	-		
	Ports 1 to 3*1 Ports 7 to B*1 Ports D, E, and G*1	V_{IH}	VCC×0.8	-	VCC+0.3		
		V_{IL}	-0.3	-	VCC×0.2		
		ΔV_T	VCC ×0.06	-	-		
Input high voltage (except Schmitt trigger input pin)	MD pin, EMLE	V_{IH}	VCC×0.9	-	VCC+0.3	V	
	EXTAL RSPI input pin		VCC×0.8		VCC+0.3		
	RIIC input pin (SMBus)		2.1		VCC+0.3		Conditions 1 and 2
Input low voltage (except Schmitt trigger input pin)	MD pin, EMLE	V_{IL}	-0.3	-	VCC×0.1	V	
	EXTAL RSPI input pin		-0.3	-	VCC×0.2		
	RIIC input pin (SMBus)		-0.3	-	0.8		Conditions 1 and 2

Table 5.2 DC Characteristics (1) (3 / 3)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input capacitance	All input pins (except for ports PB1 and PB2)	C_{in}	-	-	15	pF	V_{in} = 0 V, f = 1 MHz, T_a = 25°C
	Ports PB1 and PB2		-	-	30		

Note 1. This includes the multiplexed input pins, except in cases where port pins PB1 and PB2 are used as RIIC input pins or port pins P22 to P24, P30, PA3 to PA5, PB0, PD0 to PD2, or PD6 are used as RSPI input pins.

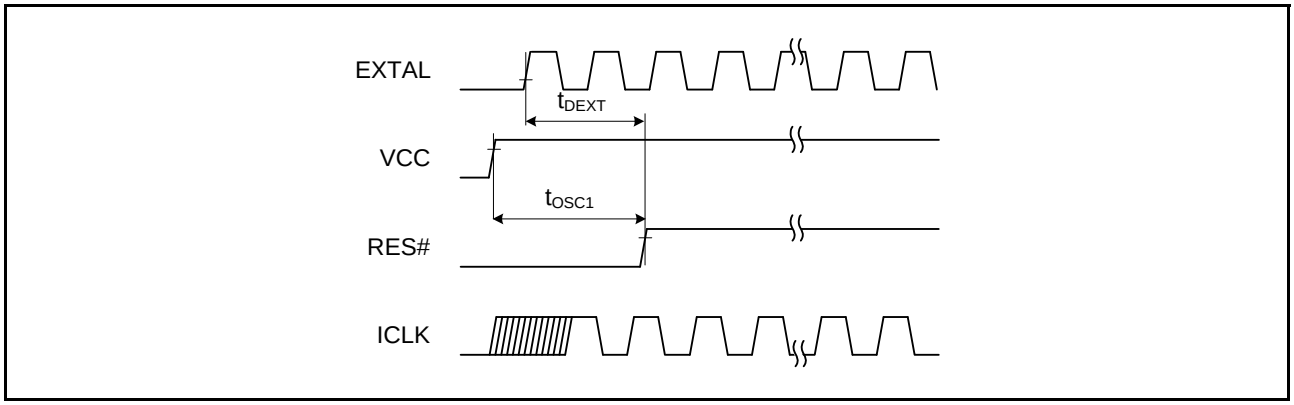


Figure 5.1 Oscillation Settling Timing

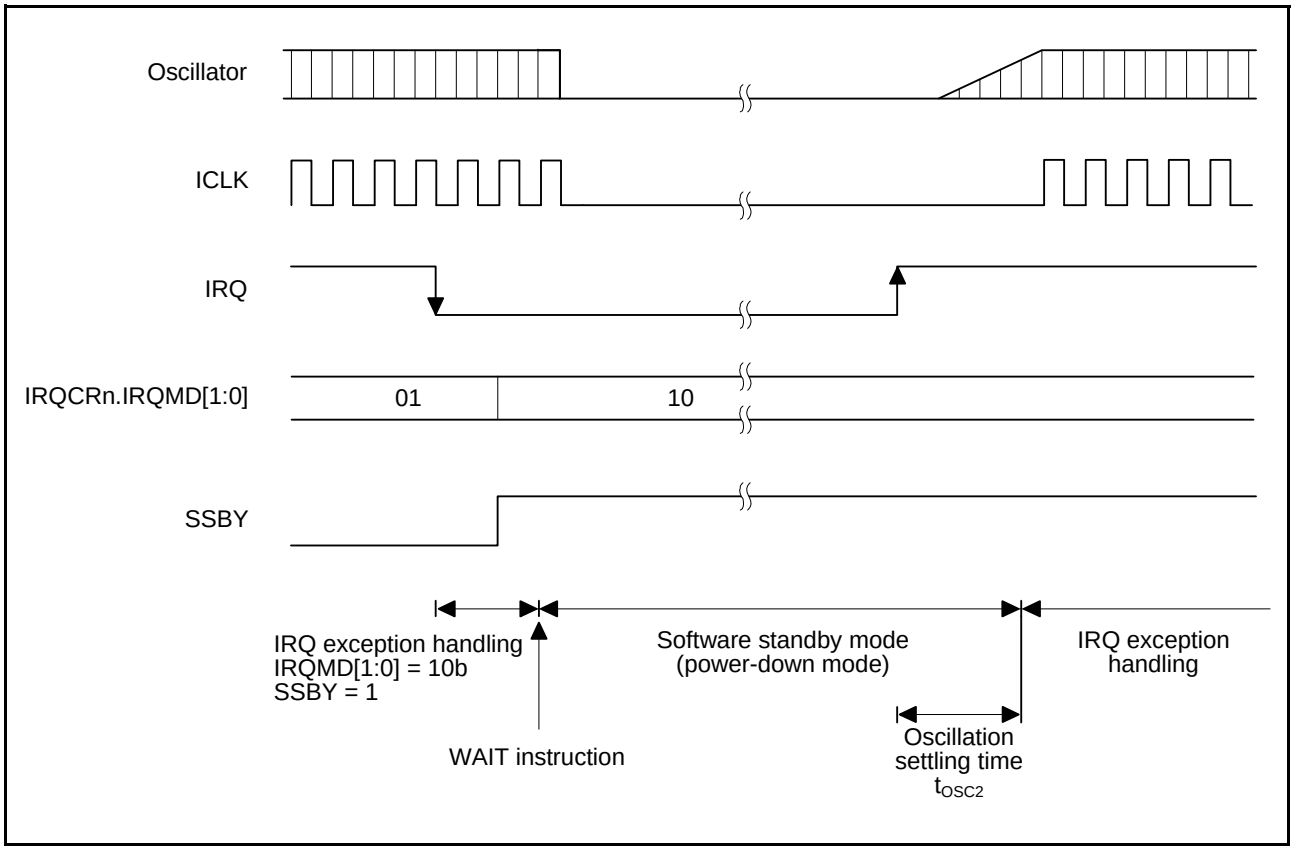


Figure 5.2 Oscillation Settling Timing after Software Standby Mode

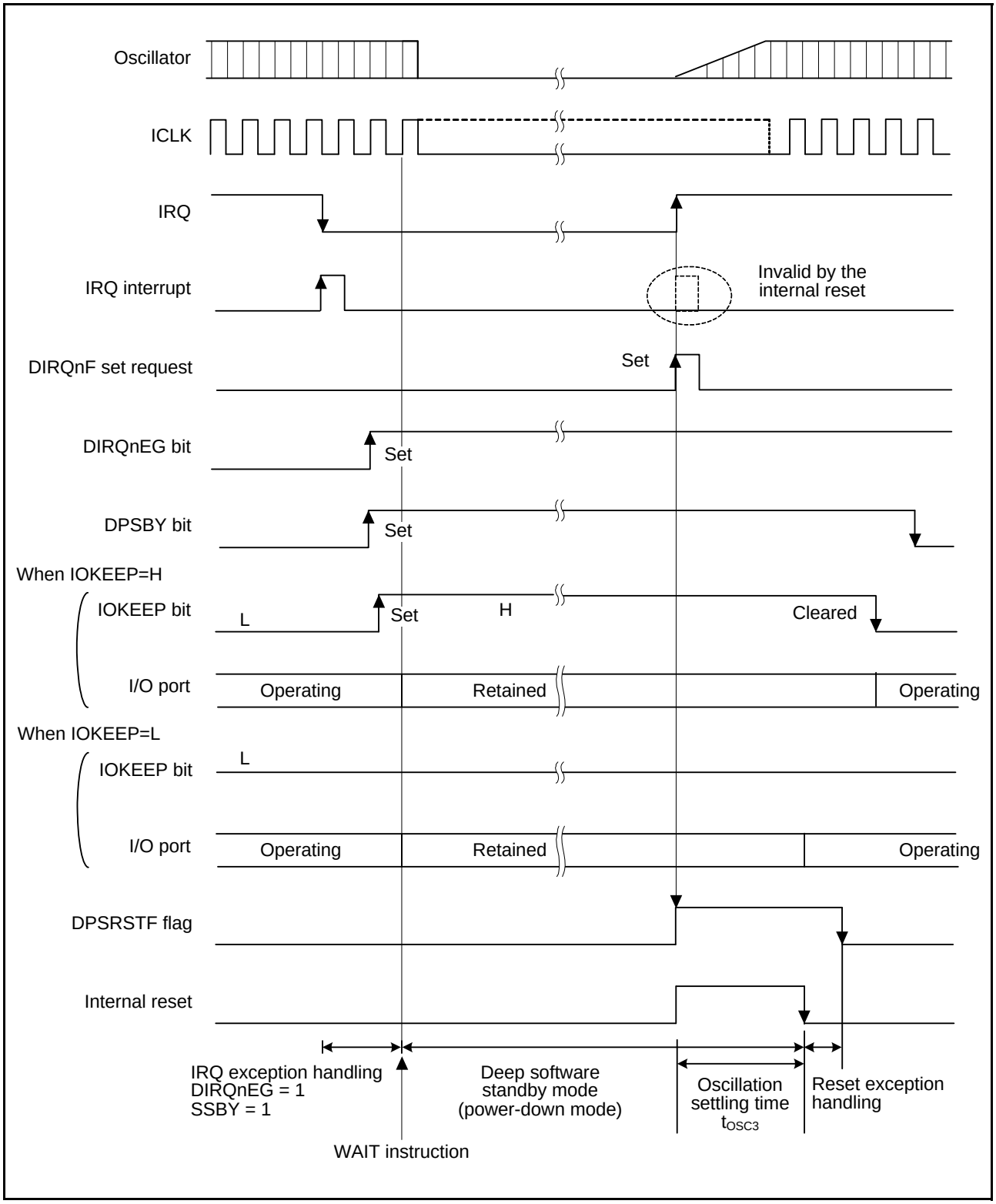


Figure 5.3 Oscillation Settling Timing after Deep Software Standby Mode

Table 5.10 Timing of On-Chip Peripheral Modules (2)

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.*1 *2	Max.	Unit	Test Conditions
RIIC (standard mode)	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 1300	-	ns	Figure 5.10
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	-	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 1000	-	ns	
	SCL, SDA input rising time	t_{Sr}	-	1000	ns	
	SCL, SDA input falling time	t_{Sf}	-	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	-	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	-	ns	
	Re-start condition input setup time	t_{STAS}	1000	-	ns	
	Stop condition input setup time	t_{STOS}	1000	-	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	-	ns	
	Data input hold time	t_{SDAH}	0	-	ns	
	SCL, SDA capacitive load	C_b	-	400	pF	
RIIC (fast mode)	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 600	-	ns	
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	-	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 300	-	ns	
	SCL, SDA input rising time	t_{Sr}	20 + 0.1C_b	300	ns	
	SCL, SDA input falling time	t_{Sf}	20 + 0.1C_b	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	-	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	-	ns	
	Re-start condition input setup time	t_{STAS}	300	-	ns	
	Stop condition input setup time	t_{STOS}	300	-	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	-	ns	
	Data input hold time	t_{SDAH}	0	-	ns	
	SCL, SDA capacitive load	C_b	-	400	pF	

Note: • t_{IICcyc}: Cycles of internal base clock (IICφ) for the RIIC module
Note 1. The value in parentheses is used when ICMR3.NF[1:0] are set to 11b while a digital filter is enabled with ICFER.NFE = 1.
Note 2. Cb indicates the total capacity of the bus line.

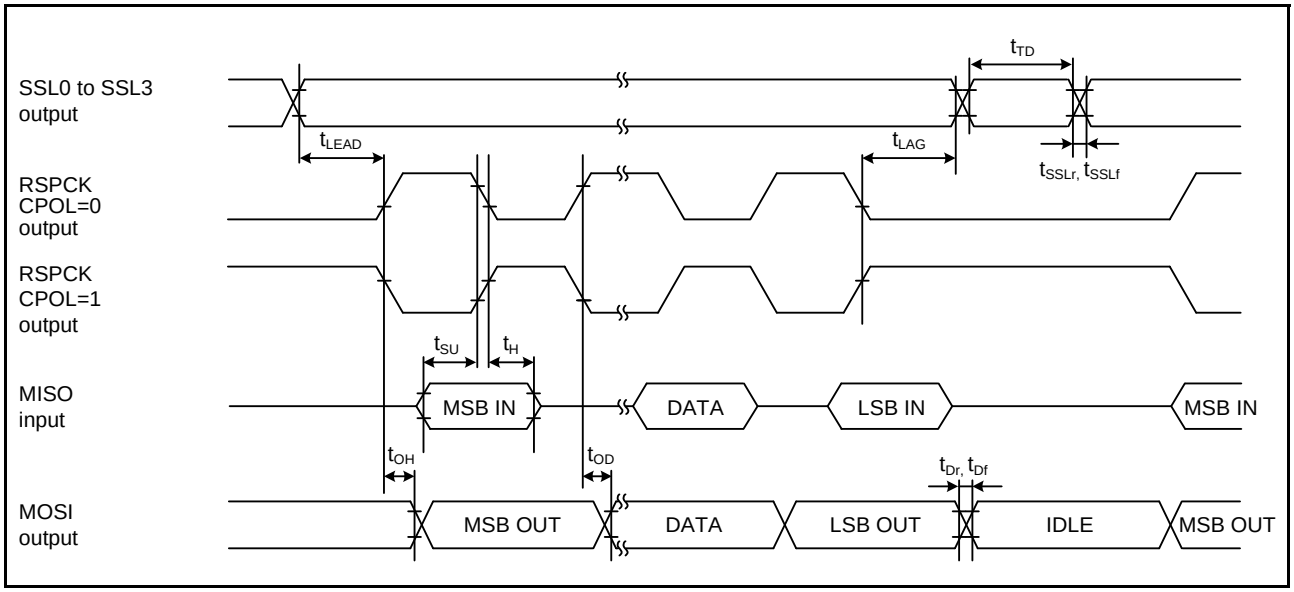


Figure 5.13 RSPI Timing (Master, CPHA = 1)

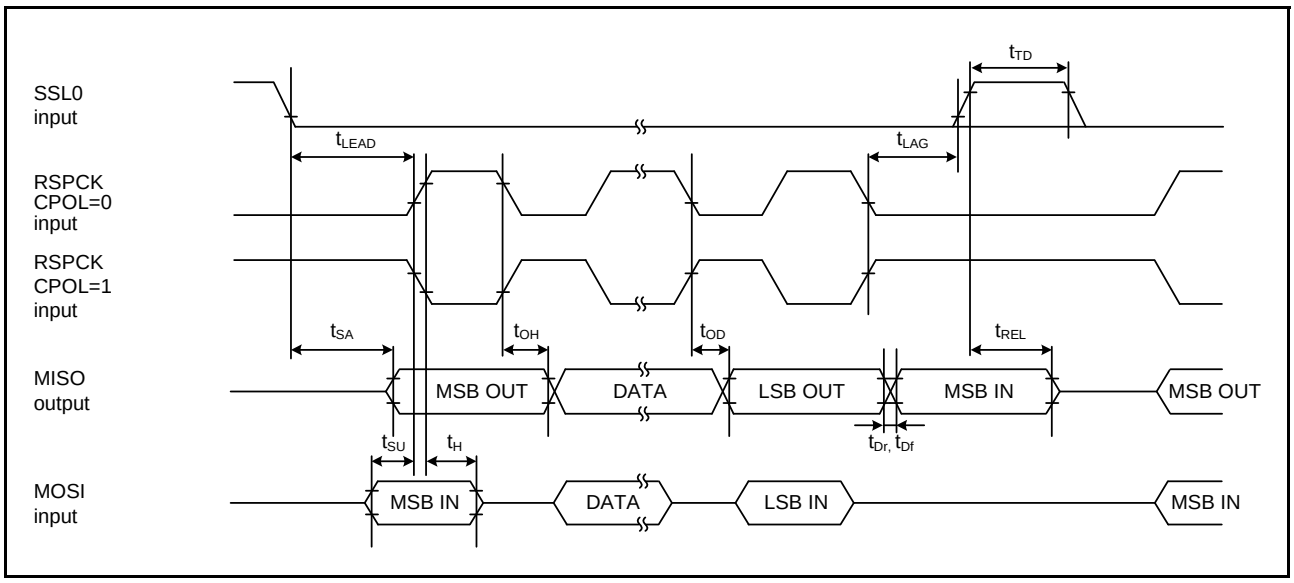


Figure 5.14 RSPI Timing (Slave, CPHA = 0)

5.4 A/D Conversion Characteristics

Table 5.15 10-Bit A/D Conversion Characteristics

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC
Ta = Topr

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time*1 (AD clock = 25-MHz operation)	2.0	-	-	μs	Sampling 25 states
Analog input capacitance	-	-	4	pF	
Integral nonlinearity error	-	-	±3.0	LSB	
Offset error	-	-	±3.0	LSB	
Full-scale error	-	-	±3.0	LSB	
Quantization error	-	±0.5	-	LSB	
Absolute accuracy	-	-	±4.0	LSB	
Permissible signal source impedance	-	-	1.0	kΩ	

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 2 and 3.

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time*1 (AD clock = 50-MHz operation)	1.0	-	-	μs	Sampling 25 states
Analog input capacitance	-	-	4	pF	
Integral nonlinearity error	-	-	±3.0	LSB	
Offset error	-	-	±3.0	LSB	
Full-scale error	-	-	±3.0	LSB	
Quantization error	-	±0.5	-	LSB	
Absolute accuracy	-	-	±4.0	LSB	
Permissible signal source impedance	-	-	1.0	kΩ	

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Table 5.18 Comparator Characteristics

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC
Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Analog input capacitance	Cin	-	-	6	pF	
REFH pin offset voltage	Voff	-	-	5	mV	
REFL pin offset voltage		-	-	5	mV	
REFH input voltage range	Vin	1.7	-	AVcc – 0.3	V	
REFL input voltage range		0.3	-	AVcc – 1.7	V	
REFH reply time	tCR	-	-	1	µs	
REFL reply time	tCF	-	-	1	µs	

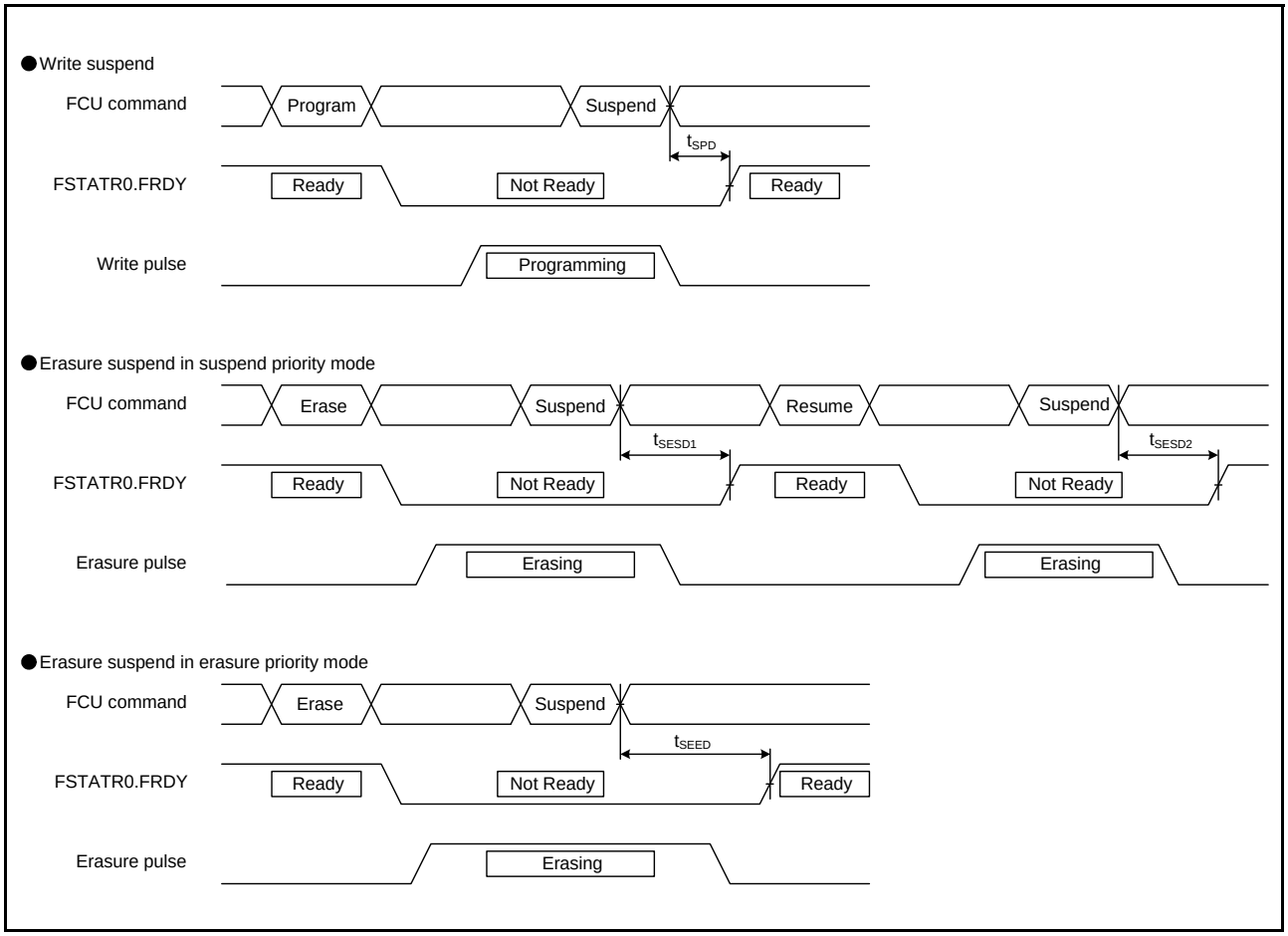
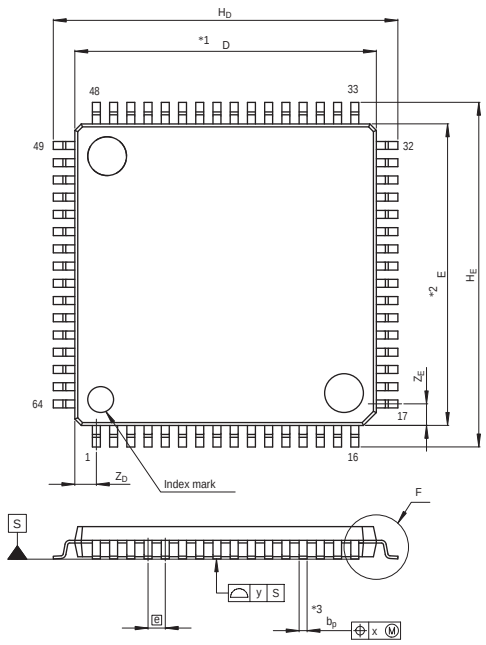
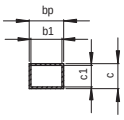


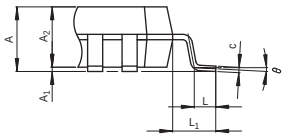
Figure 5.24 Flash Memory Write/Erase Suspend Timing

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-14x14-0.80	PLQP0064GA-A	64P6U-A/ —	0.7g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.32	0.37	0.42
b_1	—	0.35	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.8	—
x	—	—	0.20
y	—	—	0.10
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.3	0.5	0.7
L_1	—	1.0	—

Figure E 64-Pin LQFP (PLQP0064GA-A) Package Dimensions

Rev.	Date	Description	
		Page	Summary
2.00	Jan 10, 2014	98	Table 5.1 Absolute Maximum Ratings, changed
		102	Table 5.3 DC Characteristics (2): Note 3, changed
		103	Table 5.5 Permissible Power Consumption, added
		117	5.3.4 Timing of PWM Delay Generation Circuit, added
		117	Table 5.14 Timing of the PWM Delay Generation Circuit, added
		120	Table 5.17 Characteristics of the Programmable Gain Amplifier, changed
		125	Table 5.21 ROM (Flash Memory for Code Storage) Characteristics (1), changed
		125	Table 5.22 ROM (Flash Memory for Code Storage) Characteristics (2), added
		126	Table 5.23 Data Flash (Flash Memory for Data Storage) Characteristics (1), changed
		126	Table 5.24 Data Flash (Flash Memory for Data Storage) Characteristics (2), added